

## MJE800/801/802/803

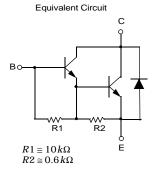
### Monolithic Construction With Built-in Base-**Emitter Resistors**



## **NPN Epitaxial Silicon Darlington Transistor**

## Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter		Value	Units
V <sub>CBO</sub>	Collector- Base Voltage	: MJE800/801	60	V
		: MJE802/803	80	V
V <sub>CEO</sub>	Collector-Emitter Voltage	: MJE800/801	60	V
		: MJE802/803	80	V
V <sub>EBO</sub>	Emitter-Base Voltage		5	V
I <sub>C</sub>	Collector Current		4	Α
I <sub>B</sub>	Base Current		0.1	Α
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)		40	W
TJ	Junction Temperature		150	°C
T <sub>STG</sub>	Storage Temperature		- 55 ~ 150	°C



## **Electrical Characteristics** $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Param	eter	Test Condition	Min.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage : MJE800/801 : MJE802/803		$I_C = 50 \text{mA}, I_B = 0$	60 80		V V
I <sub>CEO</sub>	Collector Cut-off Current : MJE800/801 : MJE802/803		V <sub>CE</sub> = 60V, I <sub>B</sub> = 0 V <sub>CE</sub> = 80V, I <sub>B</sub> = 0		100 100	μΑ μΑ
I <sub>CBO</sub>	Collector Cut-off Cu	irrent	$V_{CB}$ = Rated $BV_{CEO}$ , $I_E$ = 0 $V_{CB}$ = Rated $BV_{CEO}$ , $I_E$ = 0 $T_C$ = 100°C		100 500	μA μA
I <sub>EBO</sub>	Emitter Cut-off Curr	ent	$V_{BE} = 5V, I_{C} = 0$		2	mA
h <sub>FE</sub>		: MJE800/802 : MJE801/803 : ALL DEVICES	$V_{CE} = 3V$ , $I_{C} = 1.5A$ $V_{CE} = 3V$ , $I_{C} = 2A$ $V_{CE} = 3V$ , $I_{C} = 4A$	750 750 100		
V <sub>CE</sub> (sat)		aturation Voltage : MJE800/802 : MJE801/803 : ALL DEVICES	$I_C = 1.5A$ , $I_B = 30mA$ $I_C = 2A$ , $I_B = 40mA$ $I_C = 4A$ , $I_B = 40mA$		2.5 2.8 3	V V V
V <sub>BE</sub> (on)		bitage : MJE800/802 : MJE801/803 : ALL DEVICES	$V_{CE} = 3V, I_{C} = 1.5A$ $V_{CE} = 3V, I_{C} = 2A$ $V_{CE} = 3V, I_{C} = 4A$		2.5 2.5 3	V V V

## **Typical Characteristics**

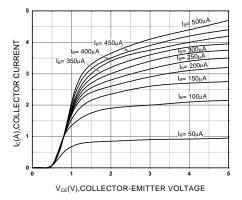


Figure 1. Static Characteristic

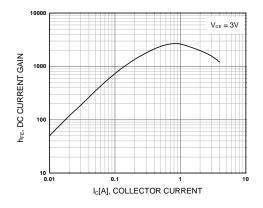


Figure 2. DC current Gain

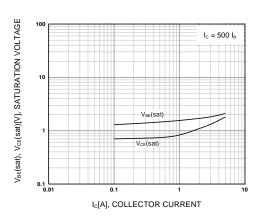


Figure 3. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

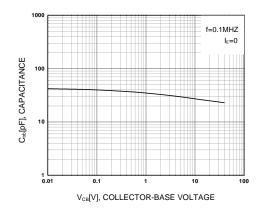


Figure 4. Collector Output Capacitance

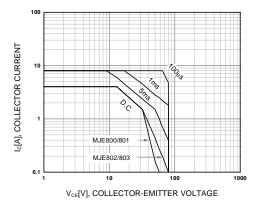


Figure 5. Safe Operating Area

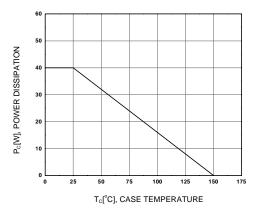
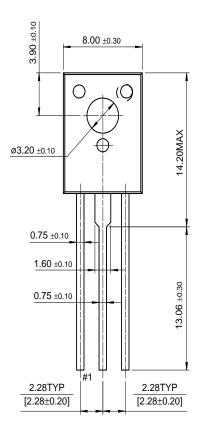


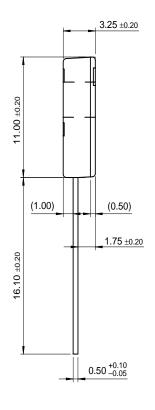
Figure 6. Power Derating

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# **Package Demensions**

TO-126







Dimensions in Millimeters

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